

Film Capacitors

EMI Suppression Capacitors (MKP)

Series/Type: B81123
Date: June 2018

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EPCOS AG is a TDK Group Company.

Y1 / 500 V AC

Typical applications

- Y1 class for interference suppression
- "Line to ground" applications
- Double insulation

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1:2013): 40/110/56

Construction

- Dielectric: polypropylene (MKP)
- Internal series connection
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Self-healing properties
- RoHS-compatible
- AEC-Q200D compliant

Terminals

- Parallel wire leads, lead-free tinned
- Standard lead lengths: 6 –1 mm
- Special lead lengths available on request

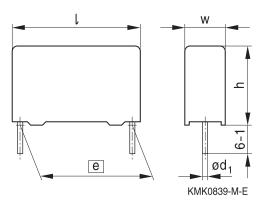
Marking

Manufacturer's logo, lot number, date code, rated capacitance (coded), cap. tolerance (code letter), rated AC voltage, series number, sub-class (Y1), dielectric code (MKP), climatic category, passive flammability category, approvals.

Delivery mode

Bulk (untaped)
Taped (Ammo pack or reel)
For taping details, refer to chapter
"Taping and packing".

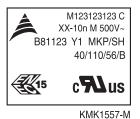
Dimensional drawing



Dimensions in mm

Lead spacing	Lead diameter d₁
<u>e</u> ±0.4	
15, 22.5	0.8

Marking example (position of marks may vary):



Please read *Cautions and warnings* and Page 2 of 18 *Important notes* at the end of this document.



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Approvals

Approval marks	Standards	Certificate
10	EN 60384-14:2014 IEC 60384-14:2013	ENEC-01093
4 15	EN 60384-14:2014 IEC 60384-14:2013	138584
71	UL 1414:2000	E97863
c FL us	UL 60384-14:2014 CSA E60384-14:2013	E97863 (approved by UL)

Notes:

Effective January 2014, only for EMI supression capacitors:

- UL 60384-14:2014 certification replaces both UL 1414:2000 and UL 1283:2005 standards.
- CSA C22.2 No.1:2004 and CSA C22.2 No.8:2013 are replaced by CSA E60384-14:2013.
- References like 1414, 1283 are removed from the capacitor marking.

Capacitors under UL 1414:2000, UL 1283:2005 produced during or before 2013, are accepted under UL scope.

Capacitors under CSA C22.2 No.1:2004 / CSA C22.2 No.8:2013 produced during or before 2013, are accepted under UL scope.

Overview of available types

Lead spacing	15 mm	22.5 mm
C _R (μF)		
0.0010		
0.0015		
0.0022		
0.0033		
0.0047		
0.0056		
0.0068		
0.010		





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Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Ammo	Reel	Untaped
spacing		$w \times h \times l$	(composition see	pack		
mm	μF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
15	0.0010	$5.0\times10.5\times18.0$	B81123C1102M***	4680	5200	4000
	0.0015	$6.0 \times 11.0 \times 18.0$	B81123C1152M***	3840	4400	4000
	0.0022	$7.0 \times 12.5 \times 18.0$	B81123C1222M***	3320	3600	4000
	0.0033	$8.5 \times 14.5 \times 18.0$	B81123C1332M***	2720	2800	2000
	0.0047	$9.0\times17.5\times18.0$	B81123C1472M***	2560	2800	2000
22.5	0.0056	$7.0\times16.0\times26.5$	B81123C1562M***	2320	2400	2520
	0.0068	$8.5\times16.5\times26.5$	B81123C1682M***	1920	2000	2040
	0.010	$10.5\times18.5\times26.5$	B81123C1103M***	1560	1600	2160

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped

(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped (lead length 6 -1 mm)







Technical data

Reference standard: IEC 60384-14:2013 / UL 60384-14:2014. All data given at T = 20 $^{\circ}$ C, unless otherwise specified.

Max. operating temperature T _{op,max}	+110 °C
Dissipation factor $\tan \delta$ (in 10 ⁻³)	at 1 kHz 1.0
at 20 °C (upper limit values)	at 100 kHz 5.0
Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{\text{ins}}$ at 20 °C, rel. humidity \leq 65% (minimum as-delivered values)	30 000 MΩ
DC test voltage	4800 V, 2 s

The repetition of this DC voltage test may damage the capacitor. Special care must be taken in case of use several capacitors in a parallel configuration.

sace of dee ceveral capacitors in a parametre comigaration.			
Passive flammability category	В		
Maximum continuous AC voltage V _{AC}	750 V (50/60 Hz)		
Rated AC voltage (UL	500 V (50/60 H	Hz)	
60384-14:2014)			
$\begin{tabular}{ll} \hline \textbf{Maximum continuous DC voltage V_{DC}} \\ \hline \end{tabular}$	3000 V		
	T _{op} ≤ 110 °C	$V_{op} = V_{AC}$	(continuously)
temperature	T _{op} ≤ 110 °C	$V_{op} = 1.25 \cdot V_{AC}$	(1000 h)
Damp heat test	56 days / 40 °C / 93% relative humidity		
Limit values after damp heat test Capacitance change $ \Delta C/C \le 5\%$		≤ 5%	
	Dissipation fac	tor change Δ tan δ	$\leq 5.10^{-3}$ (at 1 kHz)
	≤ 1.0 ⋅ 10 ⁻³ (at 100 k		$\leq 1.0 \cdot 10^{-3} \text{ (at 100 kHz)}$
	Insulation resis	stance R _{ins}	≥ 50% of minimum
	or time consta	$nt \tau = C_R \cdot R_{ins}$	as-delivered values





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Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in $V^2/\mu s$.

Note:

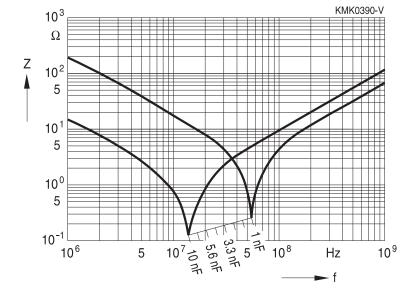
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and ko values

Lead spacing 15 mm		22.5 mm
dV/dt in V/μs	3 000	1 000
k ₀ in V²/μs	2 100 000	700 000

Impedance Z versus frequency f

(typical values)





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Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical	IEC	Voltage Proof:		Within specified limits
parameters	60384-14:2013	Detween terminals: 4000 V AC, 1 min		
		Terminals and encl	osure:	
		4000 V AC, 1 min		
		Insulation resistanc	e, R _{ins}	
		Capacitance, C		
		Dissipation factor, to	an δ	
Robustness	IEC	Tensile strength (te	st Ua1)	Capacitance and δ
of termina-	60068-2-21:2006	Wire diameter	Tensile	within specified limits
tions			force	·
		0.5 < d₁ ≤ 0.8 mm	10 N	
		$0.8 < d_1 \le 1.25 \text{ mm}$	20 N	
Resistance	IEC	Solder bath tempera		$\Delta C/C_0 \le 5\%$
to soldering	60068-2-20:2008,	260 ±5 °C, immersion		$\tan \delta$ within specified limits
heat	test Tb,	10 seconds	011 101	tarro within specified firms
ποαι	method 1A	10 00001100		
Rapid	IEC	T _A = lower category	temperature	No visible damage
change of	60384-14:2013	$T_B = \text{upper category}$	•	
temperature		B -		$tan \delta$ within specified limits
		, ,		•
Vibration	IEC	S .		No visible damage
	60384-14:2013	Displacement: 0.75		
		Accleration: 98 m/s		
		Frequency: 10 Hz		
		Test duration: 3 orth	nogonal axes,	
		2 hours each axe		No. 227 Leaders and
Bump	IEC	Test Eb: Total 4000	•	No visible damage
	60384-14:2013	400 m/s ² mounted of	on PCB	$ \Delta C/C_0 \le 5\%$
		6 ms duration		tan δ within specified limits
Climatic	IEC	Dry heat Tb / 16 h		No visible damage
sequence	60384-14:2013	Damp heat cyclic, 1	,	$ \Delta C/C_0 \le 5\%$
		+55 °C / 24 h / 95%	100% RH	
		Cold Ta / 2 h		$ \Delta \tan \delta \le 0.005 \text{ for C} > 1 \mu\text{F}$
		Damp heat cyclic, 5	-	Voltage proof
		+55 °C / 24 h / 95%	100% RH	$R_{ins} \ge 50\%$ of initial limit





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Test	Reference	Conditions of test	Performance requirements
Damp heat, steady state	IEC 60384-14:2013	Test Ca 40 °C / 93% RH / 56 days	No visible damage $\begin{split} \Delta C/C_0 &\leq 5\% \\ \Delta \tan \delta &\leq 0.008 \text{ for } C \leq 1 \mu\text{F} \\ \Delta \tan \delta &\leq 0.005 \text{ for } C > 1 \mu\text{F} \\ \text{Voltage proof} \end{split}$
Impulse test Endurance	IEC 60384-14:2013	3 impulses Tb / 1.7 $V_{\rm R}$ / 1000 hours, 1000 $V_{\rm RMS}$ for 0.1 s every hour	$\begin{split} R_{\text{ins}} & \geq 50\% \text{ of initial limit} \\ \text{No visible damage} \\ & \Delta C/C_0 \leq 10\% \\ & \Delta \tan \delta \leq 0.008 \text{ for } C \leq 1 \mu\text{F} \\ & \Delta \tan \delta \leq 0.005 \text{ for } C > 1 \mu\text{F} \\ & \text{Voltage proof} \\ & R_{\text{ins}} \geq 50\% \text{ of initial limit} \end{split}$
Passive flammability	IEC 60384-14:2013	Flame applied for a period of time depending on capacitor volume	В

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder



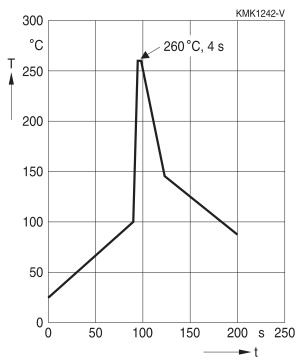




1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Serie	s	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤7.5 mm)		<4 s
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 \pm 0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$tan \delta$	As specified in sectional specification





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1.3 General notes on soldering

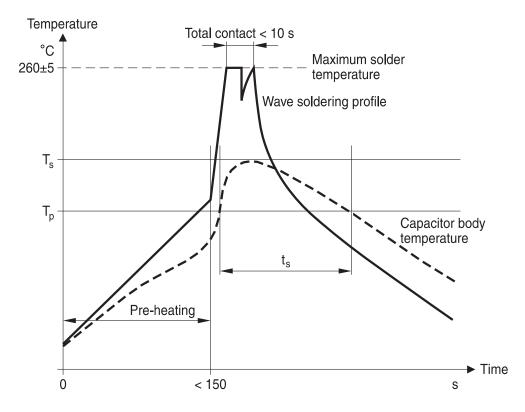
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s: Capacitor body maximum temperature at wave soldering

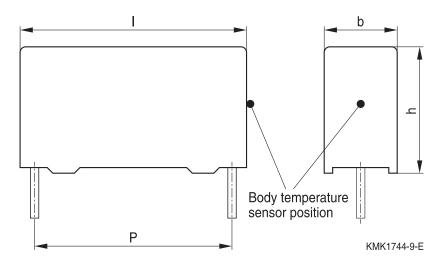
T_p: Capacitor body maximum temperature at pre-heating

KMK1745-A-E



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Body temperature should follow the description below:

■ MKP capacitor

During pre-heating: $T_p \le 110 \, ^{\circ}\text{C}$ During soldering: $T_s \le 120 \, ^{\circ}\text{C}$, $t_s \le 45 \, \text{s}$

MKT capacitor

During pre-heating: $T_p \le 125 \,^{\circ}\text{C}$ During soldering: $T_s \le 160 \,^{\circ}\text{C}$, $t_s \le 45 \,^{\circ}\text{S}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.





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Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of EPCOS.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage	Make sure that capacitors are stored within the specified	
conditions	range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive	5.3
	flammability), avoid overload of the capacitors (active	"Flammability"
	flammability) and consider the flammability of materials.	
Resistance to	Do not exceed the tested ability to withstand vibration.	5.2
vibration	The capacitors are tested to IEC 60068-2-6:2007.	"Resistance to
	EPCOS offers film capacitors specially designed for	vibration"
	operation under more severe vibration regimes such as	
	those found in automotive applications. Consult our	
	catalog "Film Capacitors for Automotive Electronics".	

Topic	Safety information	Reference chapter
		"Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits	1 "Soldering"
	during soldering.	
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"



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Topic	Safety information	Reference chapter
		"Mounting guidelines"
Embedding of	When embedding finished circuit assemblies in plastic	3 "Embedding of
capacitors in	resins, chemical and thermal influences must be taken	capacitors in finished
finished	into account.	assemblies"
assemblies	Caution: Consult us first, if you also wish to embed other	
	uncoated component types!	

Design of EMI Capacitors

EPCOS EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC 60384-14:2013 (4th edition) / UL 60384-14:2014 (2nd edition) must be performed at 1.25 × V_R at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC 60384-14:2013 (4th edition) / UL 60384-14:2014 (2nd edition) establishes high voltage tests performed at $4.3 \times V_R 1$ minute, impulse testing at 2500 V for C = 1 µF and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

Effect of humidity on capacitance stability

Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.





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Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
Ic	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_{o}	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_{i}	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ_{P}	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_{S}	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
-	and voltage	-spannung
T_op	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer





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Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_{C}	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{o}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_{R}	Rated voltage	Nennspannung
Ŷ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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